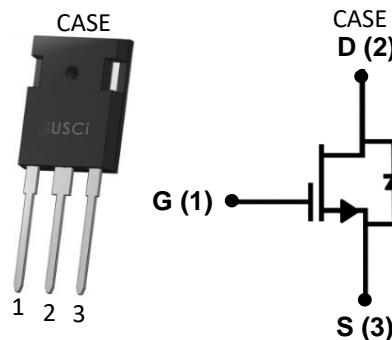


Description

United Silicon Carbide's cascode products co-package its xJ series high-performance SiC JFETs with a cascode optimized MOSFET to produce the only standard gate drive SiC device in the market today. This series exhibits ultra-low gate charge, but also the best reverse recovery characteristics of any device of similar ratings. These devices are excellent for switching inductive loads, and any application requiring standard gate drive.



Part Number	Package	Marking
UJC06505K	TO-247-3L	UJC06505K

Features

- Max. on-resistance $R_{DS(on)max}$ of 45mΩ
- Standard 12V gate drive
- Maximum operating temperature of 150°C
- Excellent reverse recovery
- Low gate charge
- Low intrinsic capacitance
- RoHS compliant

Typical Applications

- EV charging
- PV inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V_{DS}		650	V
Gate-source voltage	V_{GS}	DC	-25 to +25	V
Continuous drain current ¹	I_D	$T_C = 25^\circ C$	36.5	A
		$T_C = 100^\circ C$	23.5	A
Pulsed drain current ²	I_{DM}	$T_C = 25^\circ C$	113	A
Short-circuit withstand time ³	t_{SC}	$V_{GS}=15V, V_{DS}<300V$	4	μs
Single pulsed avalanche energy ³	E_{AS}	$L=15mH, I_{AS}=2.5A$	52	mJ
Power dissipation	P_{tot}	$T_C = 25^\circ C$	113	W
Maximum junction temperature	$T_{J,max}$		150	°C
Operating and storage temperature	T_J, T_{STG}		-55 to 150	°C
Max. lead temperature for soldering, 1/8" from case for 5 Seconds	T_L		250	°C

1 Limited by $T_{J,max}$

2 Pulse width t_p limited by $T_{J,max}$

3 Starting $T_J = 25^\circ C$

Electrical Characteristics (T_J = +25°C unless otherwise specified)
Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Drain-source breakdown voltage	BV _{DS}	V _{GS} =0V, I _D =1mA	650			V
Total drain leakage current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V, T _J = 25°C		25	500	μA
		V _{DS} = 650V, V _{GS} = 0V, T _J = 150°C		65		
Total gate leakage current	I _{GSS}	V _{DS} =0V, T _J =25°C, V _{GS} = -20V / +20V		5	100	nA
Drain-source on-resistance	R _{DS(on)}	V _{GS} =12V, I _D =25A, T _J = 25°C		34	45	mΩ
		V _{GS} =12V, I _D =25A, T _J = 150°C		62		
Gate threshold voltage	V _{G(th)}	V _{DS} = 5V, I _D = 10mA	4.5	5	5.5	V
Gate resistance	R _G	f = 1MHz, open drain		1.1		Ω

Typical Performance - Reverse Diode

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Diode continuous forward current ¹	I _S	T _C = 25°C			36.5	A
Diode pulse current ²	I _{S,pulse}	T _C = 25°C			113	A
Forward voltage	V _{FSD}	V _{GS} = 0V, I _F = 25A, T _J = 25°C		1.55	2	V
		V _{GS} = 0V, I _F = 25A, T _J = 150°C		1.9		
Reverse recovery charge	Q _{rr}	V _R =400V, I _F =25A, V _{GS} =0V, di/dt=1200A/μs, T _J = 25°C		85		nC
Reverse recovery time	t _{rr}			30		ns
Reverse recovery charge	Q _{rr}	V _R =400V, I _F =25A, V _{GS} =0V, di/dt=1200A/μs, T _J = 150°C		95		nC
Reverse recovery time	t _{rr}			33		ns

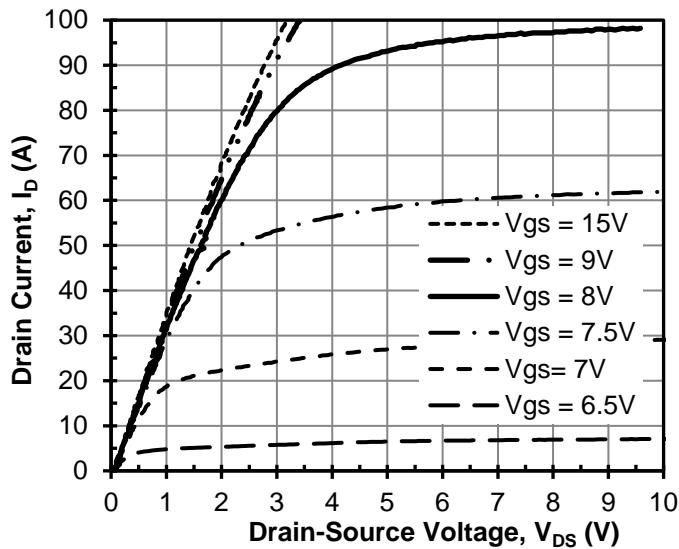
Typical Performance - Dynamic

Parameter	symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Input capacitance	C_{iss}	$V_{DS} = 400V$, $V_{GS} = 0V$, $f = 100kHz$		2107		pF
Output capacitance	C_{oss}			80		
Reverse transfer capacitance	C_{rss}			5.7		
Effective output capacitance, energy related	$C_{oss(er)}$	$V_{DS} = 0V$ to $400V$, $V_{GS} = 0V$		100		pF
Effective output capacitance, time related	$C_{oss(tr)}$	$V_{DS} = 0V$ to $400V$, $V_{GS} = 0V$		181		pF
C_{oss} stored energy	E_{oss}	$V_{DS} = 400V$, $V_{GS} = 0V$		8		μJ
Total gate charge	Q_G	$V_{DS}=400V$, $I_D = 25A$, $V_{GS}=0V$ to $12V$		47.5		nC
Gate-drain charge	Q_{GD}			15		
Gate-source charge	Q_{GS}			15		
Turn-on delay time	$t_{d(on)}$	$V_{DS}=400V$, $I_D=25A$, Gate Driver = $0V$ to $+12V$, Turn-on $R_{G,EXT} = 0\Omega$, Turn-off $R_{G,EXT} = 20\Omega$ Inductive Load, FWD: UJD06520T $T_J = 25^\circ C$		29		ns
Rise time	t_r			10		
Turn-off delay time	$t_{d(off)}$			70		
Fall time	t_f			15		
Turn-on energy	E_{ON}			196		μJ
Turn-off energy	E_{OFF}			101		
Total switching energy	E_{TOTAL}			297		
Turn-on delay time	$t_{d(on)}$	$V_{DS}=400V$, $I_D=25A$, Gate Driver = $0V$ to $+12V$, Turn-on $R_{G,EXT} = 0\Omega$, Turn-off $R_{G,EXT} = 20\Omega$ Inductive Load, FWD: UJD06520T $T_J = 150^\circ C$		31		ns
Rise time	t_r			14		
Turn-off delay time	$t_{d(off)}$			78		
Fall time	t_f			17		
Turn-on energy	E_{ON}			215		μJ
Turn-off energy	E_{OFF}			124		
Total switching energy	E_{TOTAL}			339		

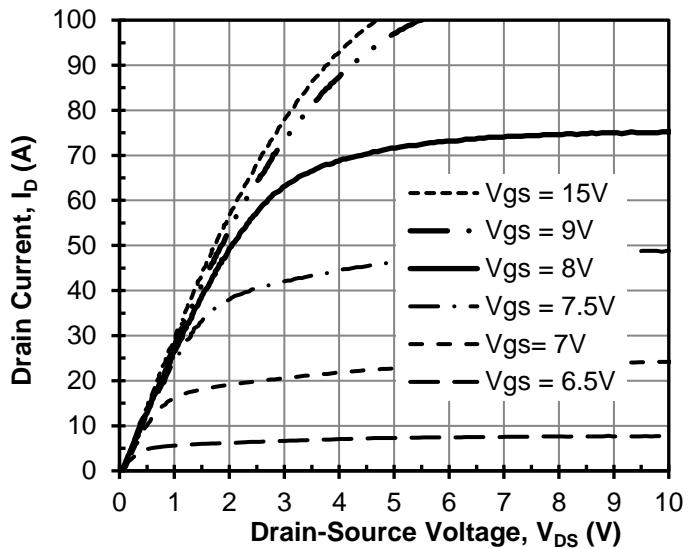
Thermal Characteristics

Parameter	symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal resistance, junction-to-case	R_{0JC}			0.84	1.1	$^\circ C/W$

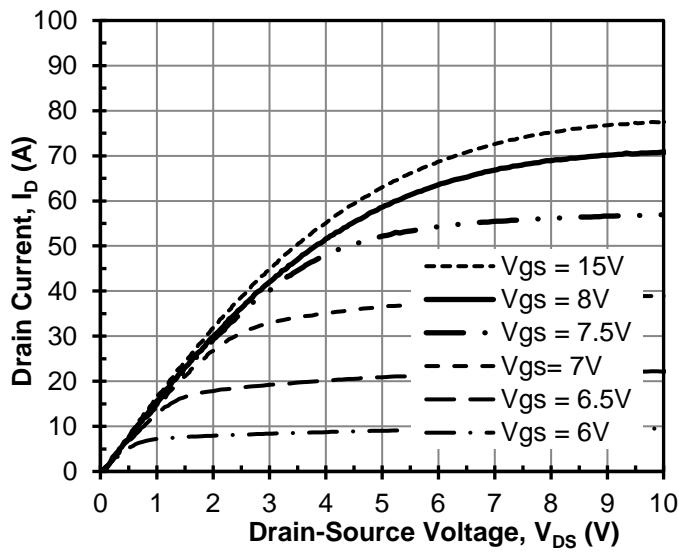
Typical Performance Diagrams



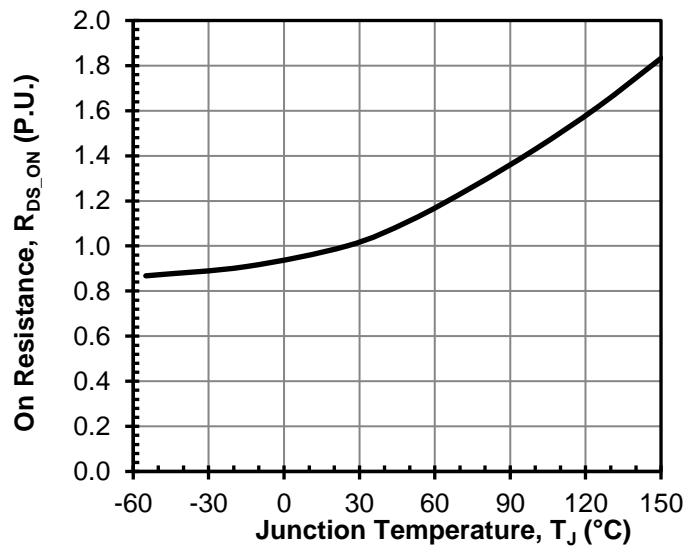
**Figure 1 Typical output characteristics
at $T_j = -55^\circ\text{C}$, $tp < 250 \mu\text{s}$**



**Figure 2 Typical output characteristics
at $T_j = 25^\circ\text{C}$, $tp < 250 \mu\text{s}$**



**Figure 3 Typical output characteristics
at $T_j = 150^\circ\text{C}$, $tp < 250 \mu\text{s}$**



**Figure 4 Normalized on-resistance vs.
temperature at $V_{GS} = 12\text{V}$ and
 $I_D = 25\text{A}$**

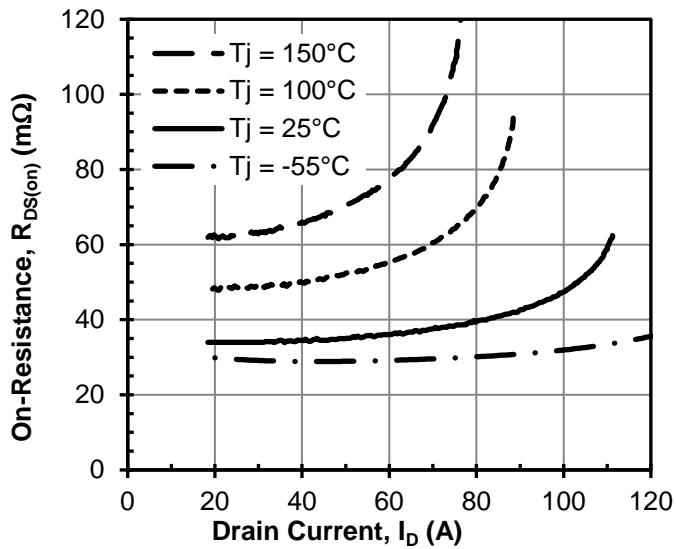


Figure 5 Typical drain-source on-resistance at $V_{GS} = 12\text{V}$

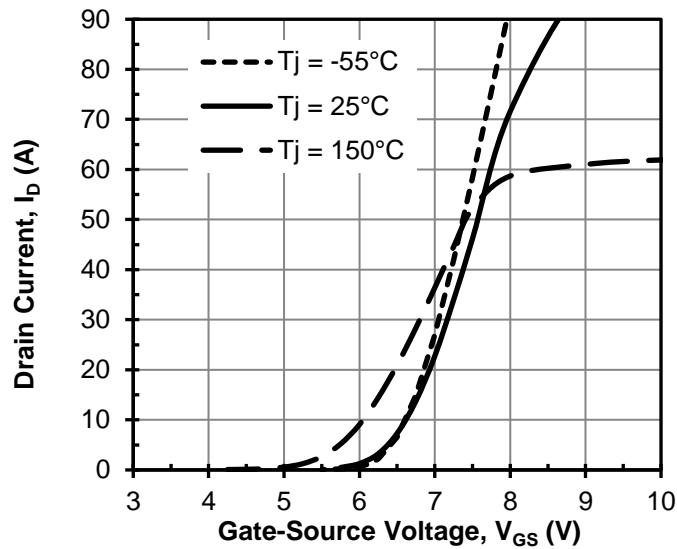


Figure 6 Typical transfer characteristics at $V_{DS} = 5\text{V}$

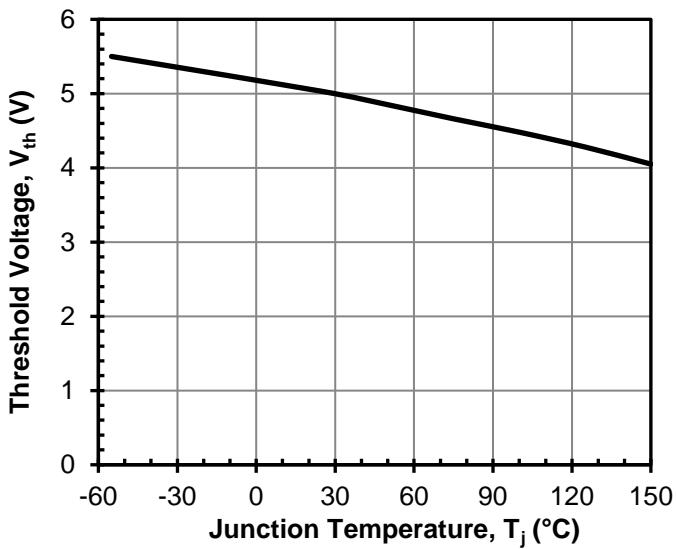


Figure 7 Threshold voltage vs. T_j at $V_{DS} = 5\text{V}$ and $I_D = 10\text{mA}$

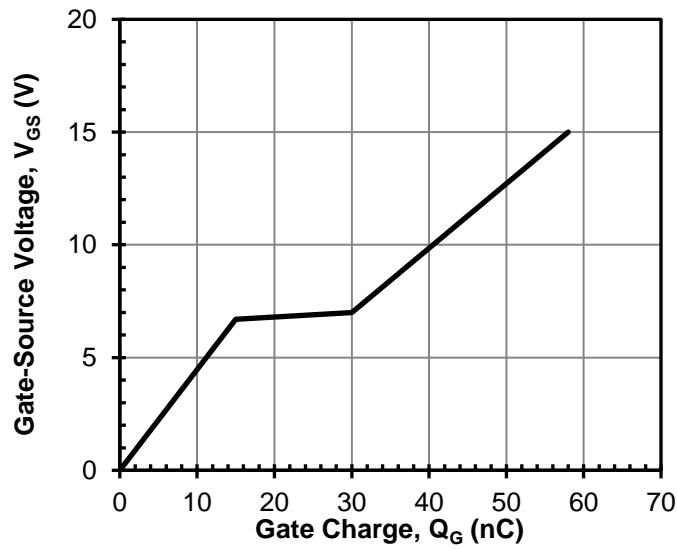
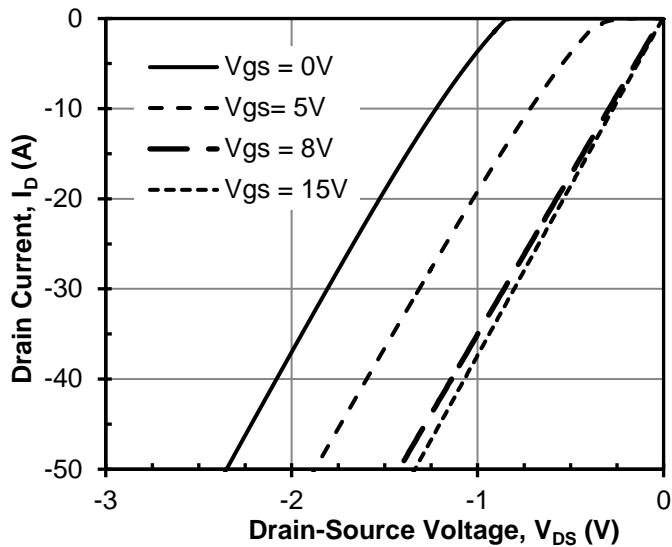
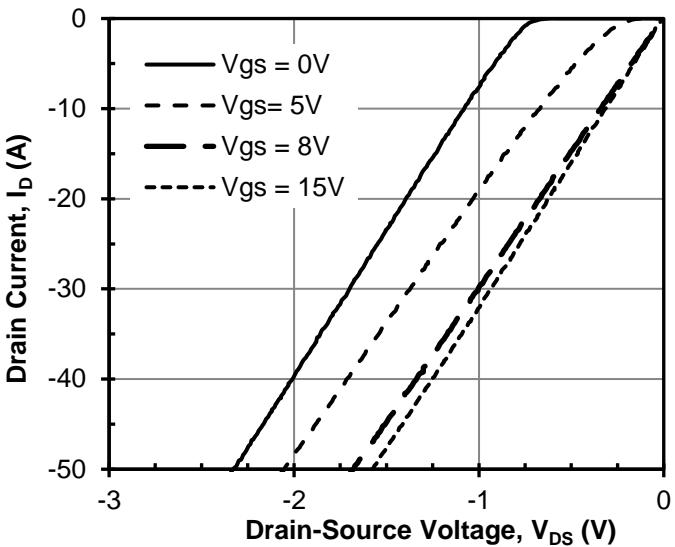


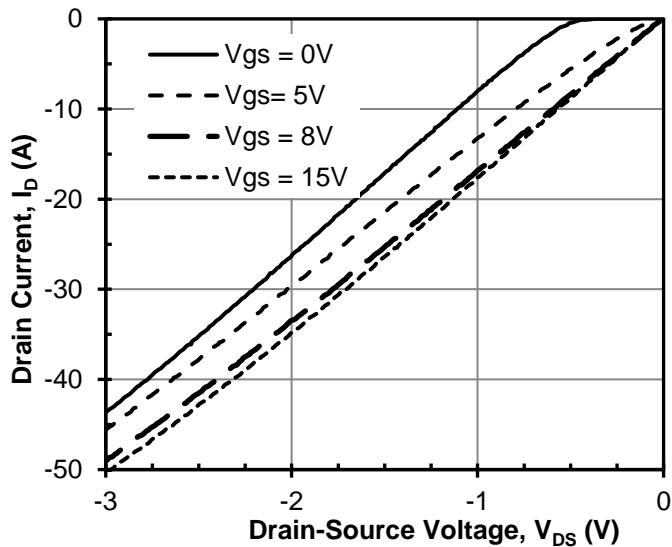
Figure 8 Typical gate charge at $V_{DS} = 400\text{V}$ and $I_D = 25\text{A}$



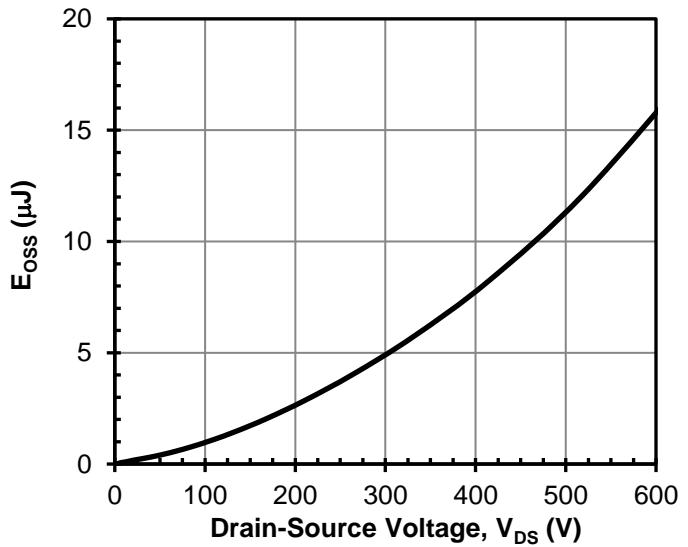
**Figure 9 3rd quadrant characteristics
at $T_J = -55^\circ\text{C}$**



**Figure 10 3rd quadrant characteristics
at $T_J = 25^\circ\text{C}$**



**Figure 11 3rd quadrant characteristics
at $T_J = 150^\circ\text{C}$**



**Figure 12 Typical stored energy in C_{oss}
at $V_{GS} = 0V$**

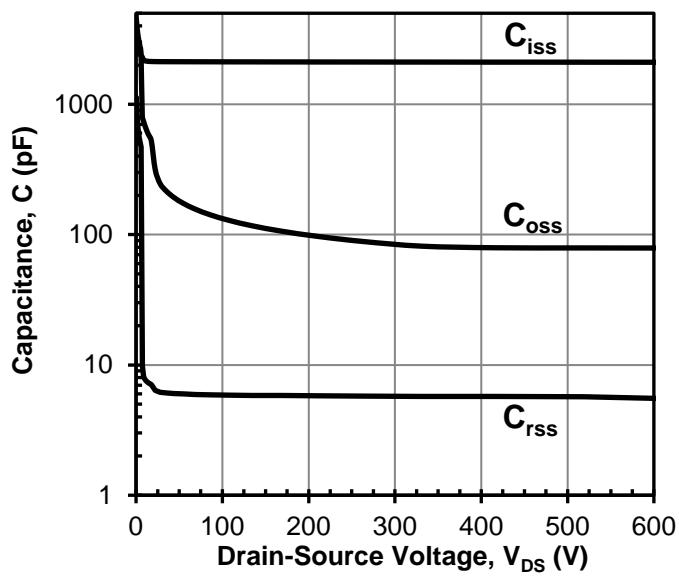


Figure 13 Typical capacitances at 100kHz
and $V_{GS} = 0V$

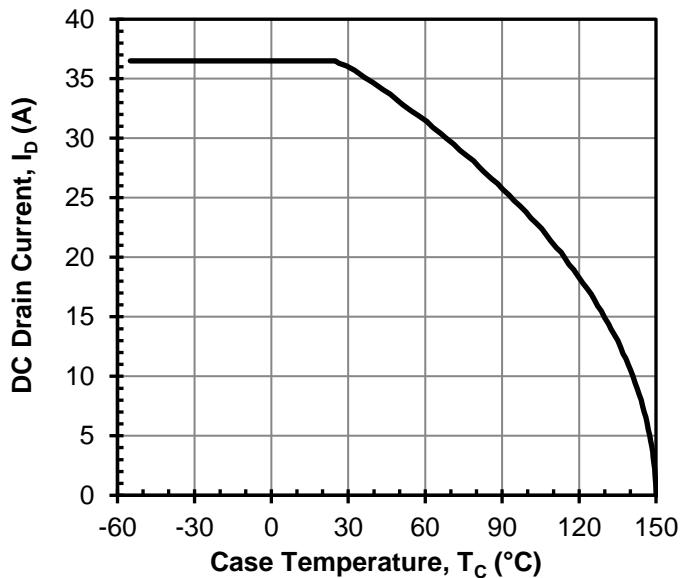


Figure 14 DC drain current derating

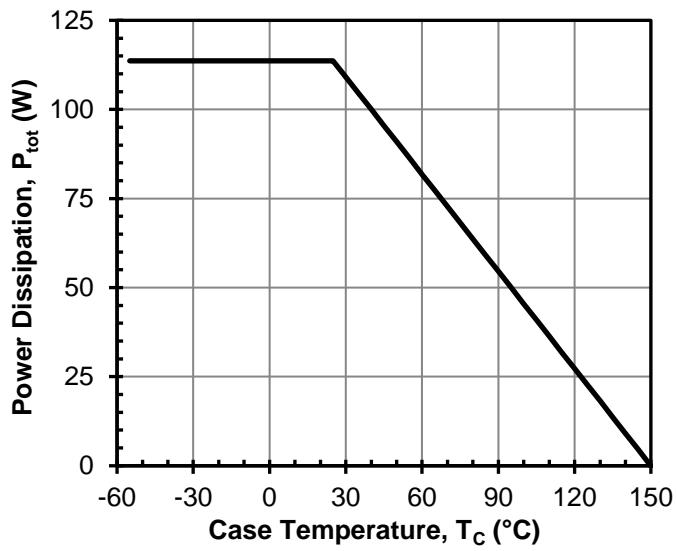


Figure 15 Total power dissipation

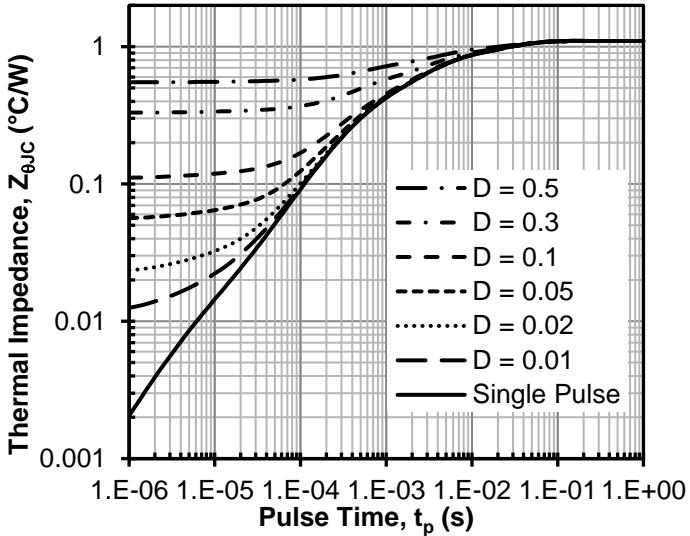
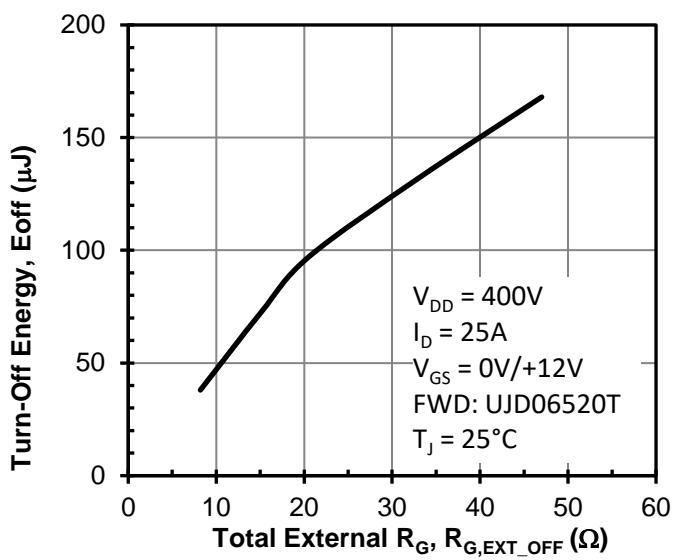
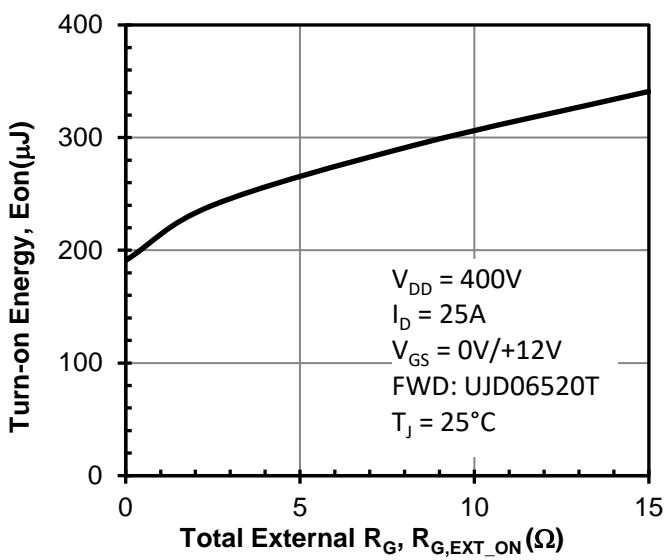
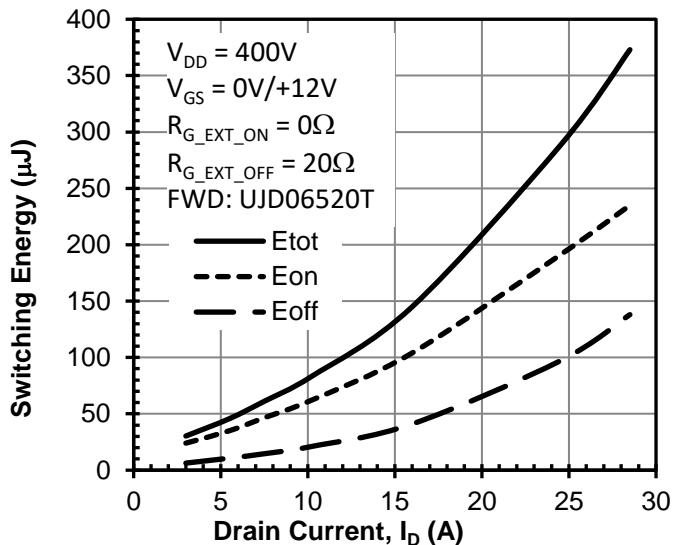
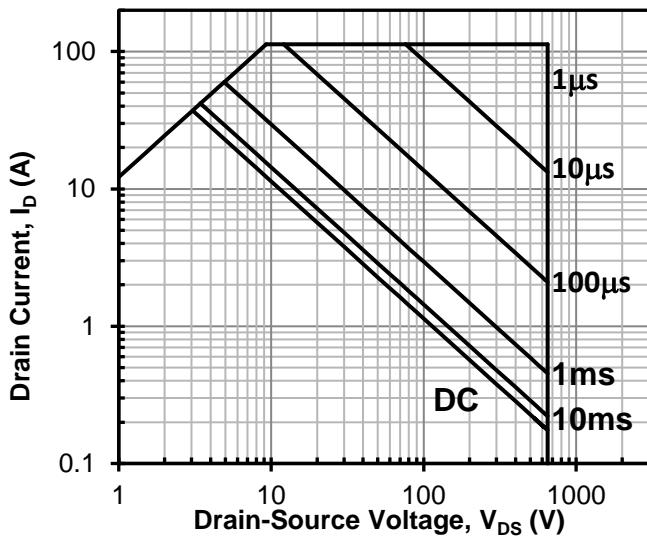


Figure 16 Maximum transient thermal impedance



Applications Information

SiC cascodes are enhancement-mode power switches formed by a high-voltage SiC depletion-mode JFET and a low-voltage silicon MOSFET connected in series. The silicon MOSFET serves as the control unit while the SiC JFET provides high voltage blocking in the off state. This combination of devices in a single package provides compatibility with standard gate drivers and offers superior performance in terms of low on-resistance ($R_{DS(on)}$), output capacitance (C_{oss}), gate charge (Q_g), and reverse recovery charge (Q_{rr}) leading to low conduction and switching losses. The SiC cascodes also provide excellent reverse conduction capability eliminating the need for an external anti-parallel diode.

Like other high performance power switches, proper PCB layout design to minimize circuit parasitics is strongly recommended due to the high dv/dt and di/dt rates. An external gate resistor is recommended when the cascode is working in the diode mode in order to achieve the optimum reverse recover performance. For more information on cascode operation, see www.unitedsic.com.

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